Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	11038	furnace near2 (idl$5 or open$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/22 12:10
L2	5206	furnace near (idl$5 or open$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/22 12:11
L3	116	(furnace near (idl$5 or open$5)) near3 (long or time)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/22 12:58
L4	26	L3 and (semiconductor or wafer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/22 12:44
L5	236	(furnace near2 (idl$5 or open$5)) near3 (long or time)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/22 12:59
L6	31	L5 and (semiconductor or wafe)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/22 12:59
L7	6	L6 not L4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/22 13:04
L8	18	702/176,177.ccls. and @pd>="20050601"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/22 13:08
L10	130	700/99,100,108.ccls. and @pd>="20050601"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/22 13:08
L11	23	700/99,100,108.ccls. and @pd>="20050601" and (furnace or oven)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/22 13:20

L12	20	700/121.ccls. and @pd>="20050601" and (furnace or oven)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/22 13:21
L13	10	L12 not L11	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/22 13:20
L14	0	700/209,306.ccls. and @pd>="20050601"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/22 13:21
L15	0	700/209,306.ccls. and @pd>="20050601"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/22 13:21
L16	16	LOGSDON-GEORGE RUST-D	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/22 13:23
S21	3196	furnace with purg$5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 14:42
S22	10	furnace with purg$5 with timer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 14:41
S23	95	700/306.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 14:41
S24	8	700/306.ccls. and (furnace or oven)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 14:41
S25	289	furnace with purg$5 with open$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 14:42

S26	58	(furnace with purg$5 with open$4) same tim$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 14:47
S27	67	(furnace with open$4 with (timer or (measur$5 near time)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 14:48
S28	2	S27 same purg$6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 14:51
S29	6	S27 same exhaust$6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 15:09
S30	110	(remain$5 near open$5) with furnace	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 15:12
S31	44	S30 and (purg$5 or exhaust$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 15:09
S32	34	S30 and (purg$5 or exhaust$5) and tim$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 15:10
S33	1	((purg$5 or exhaust$5) near2 (timer or "elapsed time")) with furnace	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 15:16
S34	239	(purg$5 or exhaust$5) with moisture with furnace	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 15:17
S35	36	S34 and (wafer or semiconductor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 15:17

S36	35	S35 and tim$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 15:17
S37	35	((purg$5 or exhaust$5) with moisture with furnace) same tim$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 17:11
S38	13	((purg$5 or exhaust$5) same moisture same furnace same tim$4) and (wafer or semiconductor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 17:18
S39	94	((purg$5 or exhaust$5) same (timer or (elapsed near time)) same furnace)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 17:18
S40	16	((purg$5 or exhaust$5) same (timer or (elapsed near time)) same furnace) and (wafer or semiconductor or substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 17:25
S41	2	furnace near cycle near purg$5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 17:26
S42	32	furnace with (cycle near purg$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 17:38
S43	35	furnace same (cycle near purg$5) same tim$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 18:27
S44	9	S43 and (wafer or semiconductor or substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 18:45
S45	12	RUST-D	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 18:37

S46	89	(detect$5 or calculat$5 or determin$5 or monitor$5) with furnace with open$2 with (tim$4 or long)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 19:39
S47	10	S46 and (wafer or semiconductor or substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 19:39
S48	39	(measur$5) with furnace with open$2 with (tim$4 or long)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 19:44
S49	3	S48 and (wafer or semiconductor or substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 19:39
S50	453	(furnace near2 open$2) and (semiconductor or wafer or substrat)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 19:45
S51	206	(furnace near open$2) and (semiconductor or wafer or substrat)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 19:45
S54	19	((monitor$5 or detect$5 or determin$5) with (furnace near3 open$2)) and (semiconductor or wafer or substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 20:00
S56	28	(furnace near3 idl$5) and (wafer and semiconductor or substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 20:15

S58	50	("4806057" "6027569" "4484538" "4369031" "5464313" "5616025" "6197373" "4934767" "6114662" "4459104" "4526534" "4857689" "5577157" "5940299" "4516897" "4550245" "4571486" "4624638" "4913929" "5217501" "5312245" "5409539" "5704667" "5746512" "5746591" "5888048" "5963833" "5994240" "6013556" "6045619" "6056123" "6157003" "6245692" "6281479" "6291801" "6442867" "6685419" "5069591" "5782942" "6015464" "4578144" "4578143" "5291025" "5506389" "5534074" "5788448" "5922619" "6113700" "6207591" "6341703").pn.	USPAT	OR	ON	2005/06/10 12:44
S59	60	(tim$4 near idl$5) and furnace and (wafer and semiconductor or substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 12:52
S60	5	((tim$4 near2 idl$5) same furnace) and (wafer and semiconductor or substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 12:53
S61	8	((tim$4 near3 idl$5) same furnace) and (wafer and semiconductor or substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 15:24
S62	73	(furnace with (idl$5 or open) with tim$5) and (semiconductor or wafer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 16:41
S63	195	(furnace with (idl$5 or open$5) with tim$5) and (semiconductor or wafer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 16:42
S64	12	((monitor$5 or determin$5) with furnace with (idl$5 or open$5) with tim$5) and (semiconductor or wafer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 16:42
S65	465	702/176,177.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 19:27

S66	4	702/176,177.ccls. and furnace	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 19:28
S67	2183	700/99,100,108,121,209.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 19:28
S68	189	700/99,100,108,121,209.ccls. and furnace	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 19:28
S69	141	700/99,100,108,121,209.ccls. and furnace and (wafer or semiconductor or substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 19:29
S70	64	700/99,100,108,121,209.ccls. and (furnace same tim$5) and (wafer or semiconductor or substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 19:29
S71	3	(furnace with idl$5 with monitor$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/12 13:33

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	208	(furnace and (idl$5 or open$5) and tim$5).clm.	US-PGPUB	OR	ON	2005/11/22 13:47
L3	83	(furnace and (idl$5 or open$5) and tim$5).clm. and (semiconductor or wafer)	US-PGPUB	OR	ON	2005/11/22 13:48
L4	0	(furnace and (idl$5 or open$5) and tim$5 and flag$5).clm.	US-PGPUB	OR	ON	2005/11/22 13:48
L5	1	(furnace and (idl$5 or open$5) and tim$5 and allocat$5).clm.	US-PGPUB	OR	ON	2005/11/22 13:48

Interference Search History